



# **GLASS PASSIVATED BRIDGE RECTIFIERS**

### REVERSE VOLTAGE – FORWARD CURRENT –

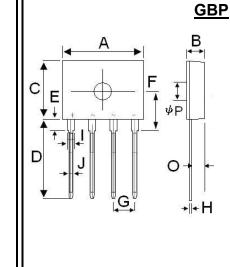
## 1000 Volts 8.0 Amperes

FEATURES

- Rating to 1000V PRV
- Ideal for printed circuit board
- Reliable construction utilizing molded plastic technique
- UL recognized file # E95060

### **MECHANICAL DATA**

- Case Material: "Green" molding compound, UL flammability classification 94V-0, (No Br. Sb. Cl)
- Polarity indicator: As marked on body
- Weight: 1.33 grams



	GBP		
Dim.	Min.	Max.	
Α	14.2	14.7	
В	2.90	3.30	
С	10.1	10.7	
D	13.8	14.4	
E	1.80	2.20	
F	6.65	7.25	
G	3.71	3.91	
Н	0.40	0.60	
I	1.20	1.40	
J	0.64	0.84	
0	1.80	2.40	
Р	3.1ψ	3.3ψ	
All Dimensions in millimeter			

#### **MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS** Ratings at 25°C ambient temperature unless otherwise specified.

#### ABSOLUTE RATINGS

PARAMETER		SYMBOL	VALUE	UNIT
Maximum repetitive peak reverse voltage		V <sub>RRM</sub>	1000	V
Maximum average forward rectified current @ T <sub>A</sub> =25°C	with heat-sink without heat-sink	I <sub>(AV)</sub>	8 1.9	A
Peak forward surge current single half sine-wave superimposed on rated load. @ $T_J=25^{\circ}C$	@8.3ms @1.0ms	I <sub>FSM</sub>	165 330	А
I <sup>2</sup> t rating for fusing (t = 8.3ms)		l <sup>2</sup> t	112.9	A <sup>2</sup> S
Operation and storage temperature range		T <sub>J</sub> ,T <sub>STG</sub>	-55 to +150	°C

#### STATIC ELECTRICAL CHARACTERISTICS

PARAMETER	TEST CO	NDITIONS	SYMBOL	MAX.	UNIT
Forward voltage	IF=4.0 A	T <sub>J</sub> =25°C	VF	1.0	V
Leakage current	VR=1000 V	TJ=25°C TJ=125°C	I <sub>R</sub>	1.0 100	uA
Typical junction capacitance (Note1)			CJ	45	pF

#### THERMAL CHARACTERISTICS

THERMAL CHARACTERISTIC	SYMBOL	TYP.	UNIT
Typical thermal resistance (without heatsink)	RthJ <sub>C</sub> RthJ∟ RthJ <sub>A</sub>	13 17 35	°C/W
Typical thermal resistance (with heatsink)(Note4)	RthJ <sub>C</sub> RthJ <sub>L</sub> RthJ <sub>A</sub>	3 6 8	°C/W
Note :			REV-1, Sept-2021, KBDG14

(1) Perform static test after the temperature of oven is steady 20 minutes.

(2) Measured at 1.0MHz and applied reverse voltage of 4.0V DC

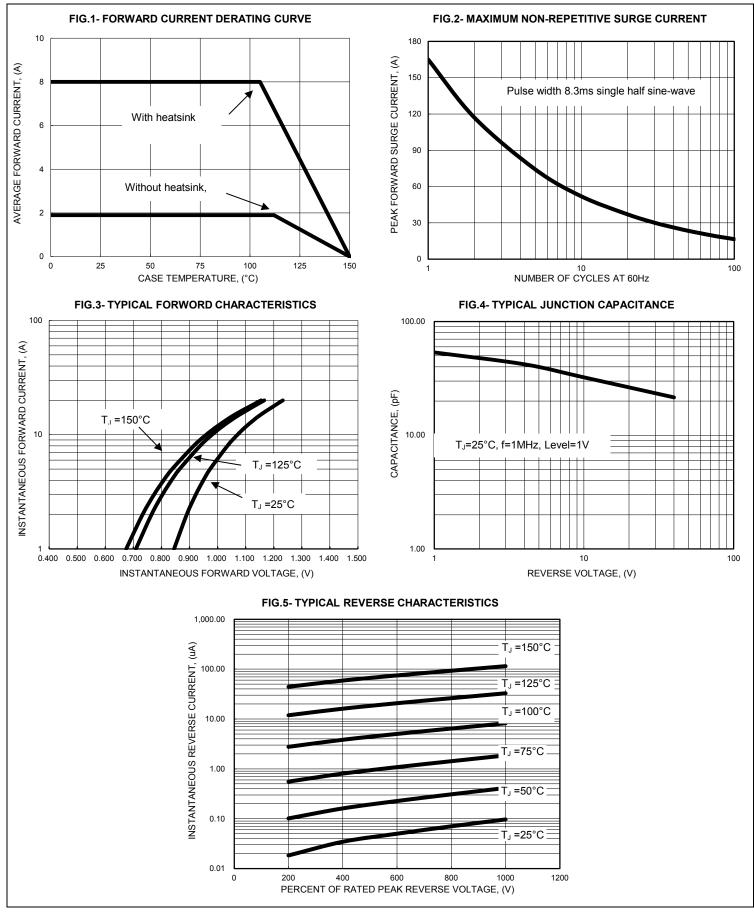
(3) Thermal resistance junction to case, lead and ambient in accordance with JESD-51.

(4) Unit mounted on attached copper pad 200mm \* 200mm \* 7mm fin type heatsink.



# LITE-ON SEMICONDUCTOR

# RATING AND CHARACTERISTIC CURVES GBP810(LS)

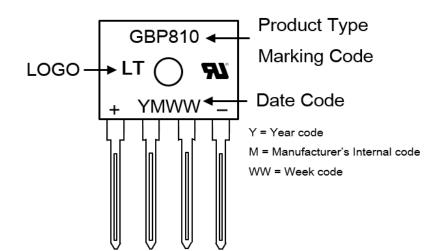




# Ordering Information :

Part Number	Case	Packaging
GBP810_HF	GBP	35 Pieces/Tube

# Marking Information :





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